

January 2015

FDMC8010ET30

N-Channel PowerTrench[®] MOSFET 30 V, 174 A, 1.3 m Ω

Features

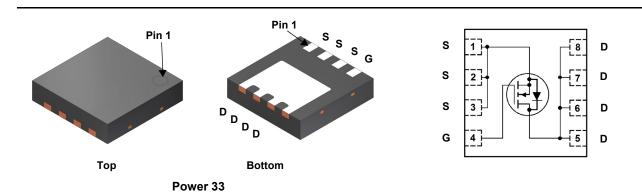
- Extended T_J rating to 175°C
- Max $r_{DS(on)}$ = 1.3 m Ω at V_{GS} = 10 V, I_D = 30 A
- Max $r_{DS(on)}$ = 1.8 m Ω at V_{GS} = 4.5 V, I_D = 25 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for applications where ultra low $r_{DS(on)}$ is required in small spaces such as High performance VRM, POL and Oring functions.

Applications

- DC DC Buck Converters
- Point of Load
- High Efficiency Load Switch and Low Side Switching
- Oring FET



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Volage		(Note 4)	±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 6)	174		
	-Continuous	T _C = 100 °C	(Note 6)	123		
	-Continuous	T _A = 25 °C	(Note 1a)	30	Α	
	-Pulsed		(Note 5)	835		
E _{AS}	Single Pulse Avalance Energy		(Note 3)	153	mJ	
P _D	Power Dissipation	ower Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		65	14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.8	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8010ET	FDMC8010ET30	Power 33	13 "	12 mm	3000 units

FDMC8010ET30
N-Channel I
PowerTrench [®]
MOSFET

Units

						1
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, referenced to 25 °C		15		mV/°C
	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μA
I _{DSS}	Gate to Source Leakage Current	$V_{\rm DS} = 20 \text{ V}, V_{\rm DS} = 0 \text{ V}$			100	nA
I _{GSS}	-				100	10 (
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.2	1.5	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 1 mA, referenced to 25 °C		-5		mV/°C
		V _{GS} = 10 V, I _D = 30 A		0.9	1.3	_
r _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 4.5 V, I_{D} = 25 A		1.3	1.8	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 30A, T_J = 125 \text{ °C}$		1.3	2	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 30 A		188		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			4405	5860	pF
C _{oss}	Output Capacitance	$-V_{DS} = 15 V, V_{GS} = 0 V,$		1570	2090	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		167	250	pF
R _g	Gate Resistance		0.1	0.5	1.25	Ω
Switchin	g Characteristics				1	
t _{d(on)}	Turn-On Delay Time			15	27	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 30 A,		7.5	15	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		40	64	ns
t _f	Fall Time			5.3	11	ns
Qg	Total Gate Charge	V_{GS} = 0 V to 10 V		67	94	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 4.5 V V_{DD} = 15 V,		32	45	nC
Q _{gs}	Gate to Source Charge	I _D = 30 A		10		nC
Q _{gd}	Gate to Drain "Miller" Charge			9.5		nC
Drain-So	urce Diode Characteristics					
		V _{GS} = 0 V, I _S = 2 A (Note 2)		0.6	1.2	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 30 A$ (Note 2)		0.7	1.2	V
t _{rr}	Reverse Recovery Time			49	78	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 30 A, di/dt = 100 A/μs		29	46	nC
overr Notes:	Neverse Necovery onarge			20	-10	110
1. R _{θJA} is deterr	mined with the device mounted on a 1 in ² pad 2 oz copper p a. 53 °C/W when moun 1 in ² pad of 2 oz co	ted on a b. 1	125 °C/W wł	d by the user nen mounted id of 2 oz cop	on a	gn.
		88888				
		G PRS SS				
	o Front S					
2. Pulse Test: P	Pulse Width < 300 μ s, Duty cycle < 2.0 %.					
	J is based on starting T_J = 25 °C, L = 0.3 mH, I _{AS} = 32 A, V	$V_{\rm DD}$ = 27 V, V_{\rm GS} = 10 V. 100% test at L = 0.1 mH, I _A	_S = 47 A.			
	evice, the negative Vgs rating is for low duty cycle pulse occ					
5. Pulsed Id ple	ase refer to Fig 11 SOA graph for more details.					
	ntinuous surrent limited to Max, lunction Temperature only	actual continuous current will be limited by thermal	electro me	chanical and	lication boa	d design
6.Computed cor	ntinuous current limited to Max Junction Temperature only, a	actual continuous current will be inflited by thermal o	x electio-file	chanical app	lication boai	a acsign.

Test Conditions

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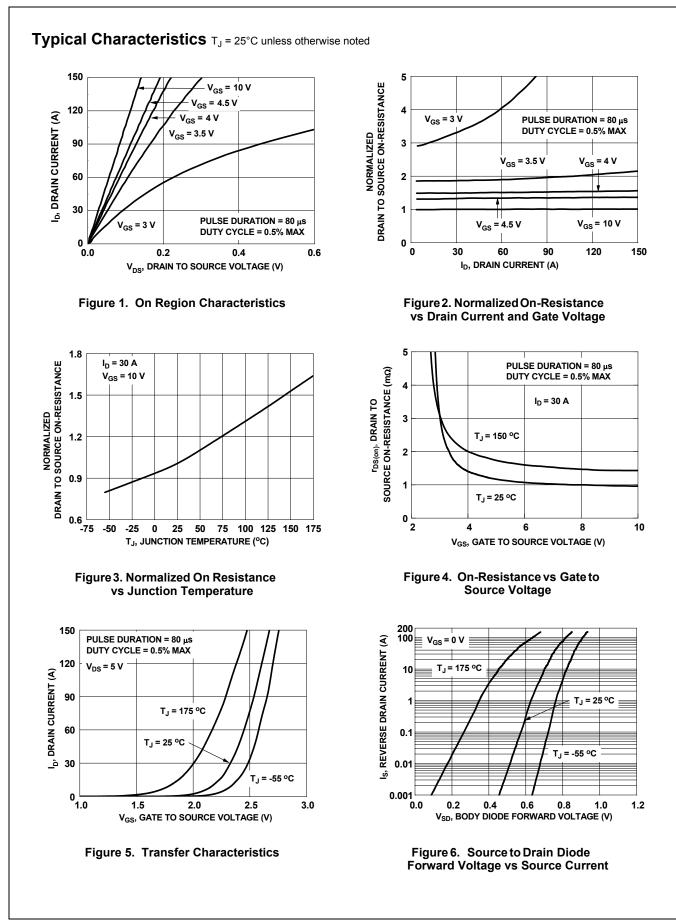
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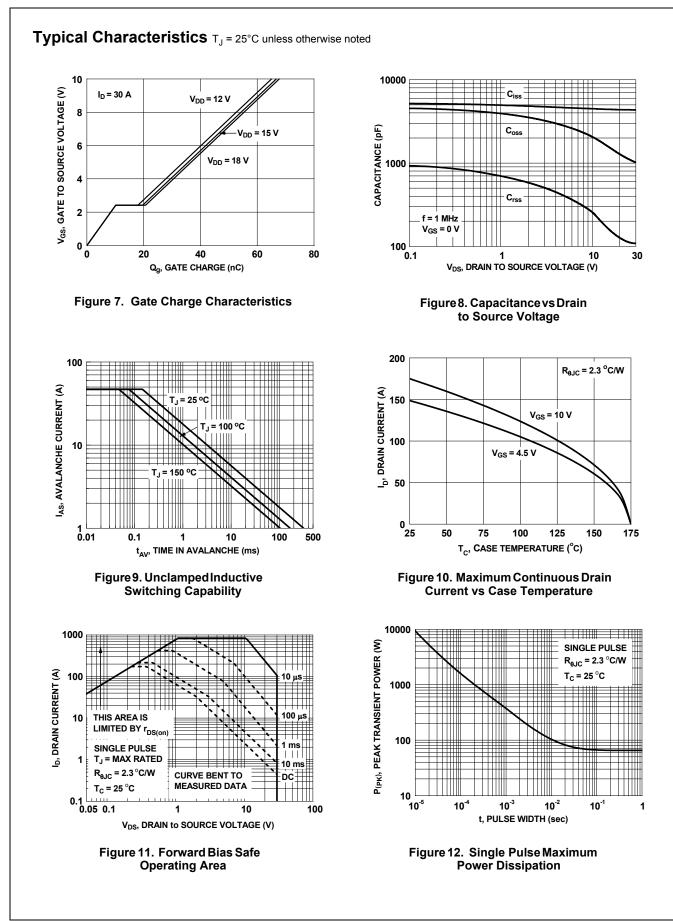
Electrical Characteristics T_J = 25 °C unless otherwise noted

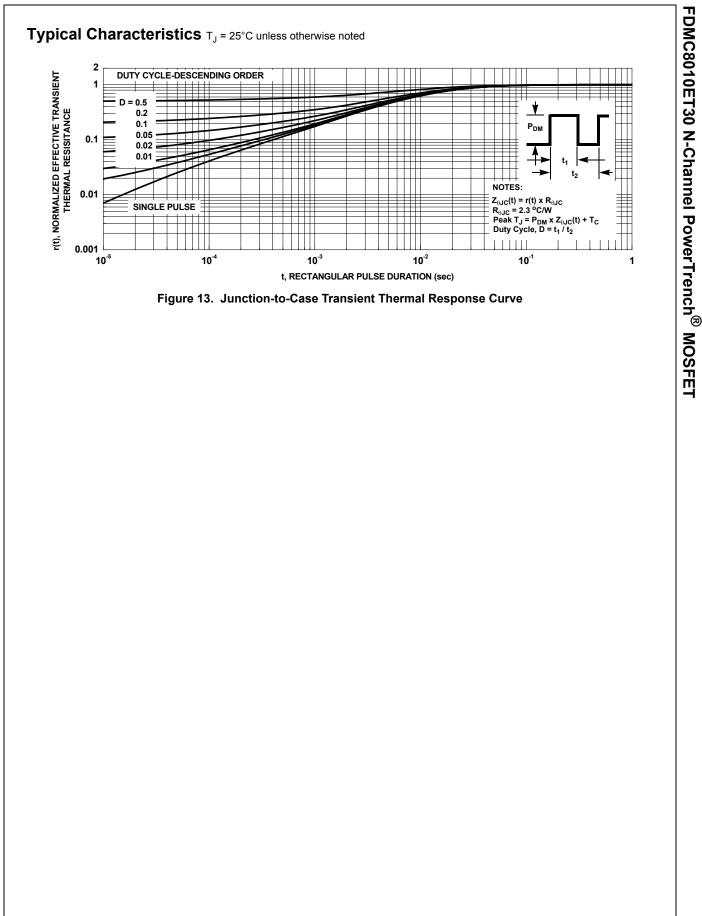
Parameter

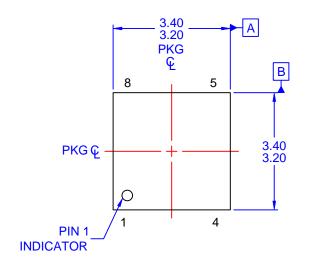
Symbol

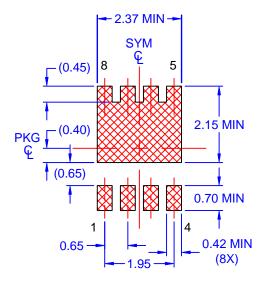
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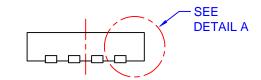


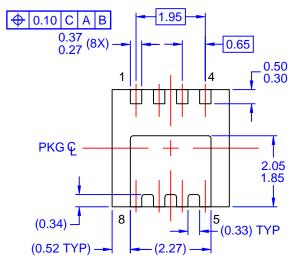


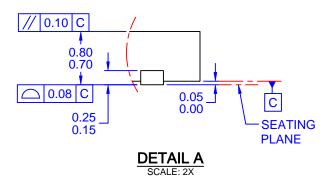












NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. BA, DATED OCTOBER 2002.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08HREV1



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